Data recording disk drive and capacitive sensor assembly

A data recording disk drive has one or more capacitive sensors for sensing out-of-plane vibration of the disk or disks. The sensors are attached to a support structure that is attached to the disk drive housing. Each sensor is associated with a disk and faces a surface of the disk near the outer perimeter of the disk and close to the recording head. The support structure can be made of a metal or a high-strength plastic and can be a separate structure mounted to the housing, or integrated as part of the single-piece housing casting. If it is metallic, as would be the case if it were integrated with the housing, then layers of insulating material separate the sensors from the support structure. A support structure that serves other functions in the disk drive can also function as the support structure for the capacitive sensors.
Description

[0001] This invention relates generally to data recording disk drives, such as magnetic recording hard disk drives.

[0002] Data recording disk drives have a stack of recording disks rotated by a spindle motor, and an actuator that moves the read/write heads across the surfaces of the rotating disks. Each read/write head is formed on an air-bearing slider attached to one end of a suspension. The suspension is attached at its other end to a rigid arm of the actuator and allows the slider to pitch and roll on a bearing of air generated by the rotating disk. The disk drive actuator is typically a rotary voice coil motor (VCM) that moves the actuator arm and the attached suspension and slider generally radially to position the head at the desired track under the control of a servo feedback control system that receives pre-recorded servo position information from the disk. The trend in future disk drives is a continual decrease in the spacing of the concentric data formation from the disk. The trend in future disk drives is a continual increase in the rotational speed of the tracks on the disk to increase the data storage density, and a continual increase in the rotational speed of the disk stack to decrease the data transfer time. As storage densities and rotational speeds increase, the ability to position the read/write heads to the proper data tracks and maintain the heads on the data tracks becomes more difficult. As the disk-stack rotational speed increases, air-flow turbulence near the perimeter of the disks increases, which causes axial (out-of-plane) buffeting or vibration of the disks (sometimes misleadingly called disk "flutter"). These vibrations cause track-misregistration (TMR) of the read/write heads and thus errors in reading data from and writing data to the data tracks.

[0003] The European patent application 05104636.5 addresses the problem of TMR caused by out-of-plane disk vibration by use of capacitive sensors that sense the axial displacement of the disks. The capacitive sensor associated with the disk surface being accessed for reading or writing of data provides a signal to a feedback controller that provides a correction to the servo feedback control system to thereby significantly reduce the effect on TMR caused by out-of-plane vibration of the disk. The capacitive sensors are located between the axially-spaced disks near the perimeter of the disk stack and securely mounted to the disk drive housing so that they do not experience vibration.

[0004] What is needed is a support structure for the capacitive sensors that can be integrated with a conventional disk drive in a low-cost manner without significant redesign of the disk drive housing.

[0005] This need is met by the data recording disk drive of claim 1 and the capacitive sensor assembly of claim 15. Preferred embodiments of the invention are characterized in the sub-claims. The invention relates more specifically to such disk drives that experience out-of-plane disk vibration induced by air flow during rotation of the disks. The disk drive of the invention has a support structure for disk-variation capacitive sensors.

[0006] The invention is a disk drive with one or more capacitive sensors for sensing out-of-plane vibration of the disk or disks. The sensors are attached to a support structure that is attached to the disk drive housing. Each sensor is associated with a disk and faces a surface of the disk near the outer perimeter of the disk and close to the path of the slider that supports the read/write head.

[0007] The support structure can be a separate structure mounted to the base or wall of the disk drive housing, or integrated as part of the single-piece housing casting. The support structure can be made of a metal or a high-strength plastic, if it is metallic, as would be the case if it were integrated with the housing, then layers of insulating material separate the sensors from the support structure.

[0008] A support structure that serves other functions in the disk drive can also function as the support structure for the capacitive sensors. If the disk drive includes damping plates that extend between the disks near their outer perimeter to reduce out-of-plane disk vibration, the sensors can be supported by the damping plate support structure or each sensor can be located on a corresponding damping plate. If the disk drive includes a shroud surrounding the disk stack for containing air flow inside the rotating disk stack, the capacitive sensors can be supported by the shroud support structure or integrated with the shroud. If the disk drive includes air dams between the disks for diverting airflow away from the head-suspension-arm assemblies, the capacitive sensors can be supported by the air dam support structure or each sensor can be located on a corresponding air dam. If the disk drive is a "load/unload" type of disk drive that uses load/unload ramps that extend between the disks, the sensors can be supported by the ramp support structure.

[0009] For a fuller understanding of the nature and advantages of the present invention, reference should be made to the following detailed description taken together with the accompanying figures.

Fig. 1 is a block diagram of a magnetic recording disk drive incorporating the present invention. Fig. 2A is a side view showing the spindle motor with the disk stack and the support structure for the capacitive sensors mounted to the disk drive housing. Fig. 2B is a side view showing the support structure for the capacitive sensors integrated into the single-piece housing casting. Fig. 3 is a schematic of a capacitance sensing circuit coupled to the capacitive sensors. Fig. 4A is a top view and Fig. 4B is a partial side sectional view, respectively, of a disk drive with damping plates and a plurality of capacitive sensors. Fig. 5A is a top view and Fig. 5B is a partial side sectional view, respectively, of a disk drive with a shroud located near the outer perimeter for the disk stack and a plurality of capacitive sensors. Fig. 6A is a top view and Fig. 6B is a partial side sectional view, respectively, of a disk drive with a plurality of capacitive sensors located between the disks.
sor 210 facing the top surface of disk 110. The capacitive
faces each disk surface, as shown by capacitive sen-
tion-induced TMR. A capacitive sensor is associated
support structure to address the problem of disk-vibra-
tion incorporates a plurality of capacitive sensors and a
mains on the track centerline.
155 to move the VCM actuator 104 so that the head re-
controller 150 that provides a control signal to VCM driver
input as a position-error-signal (PES) to a servo feedback
system to maintain the head on the centerline of the de-
sectors that contain head positioning information detect-
plurality of circumferentially or angularly-spaced servo
out-of-plane disk vibration. Thus, each data track has a
large enough to provide a capacitive signal but small
enough so that it is detecting substantially only "local"
axial displacement of the disk, i.e., displacement near
the slider 108. For a disk drive with 95 mm diameter disks,
the metallic plate forming the sensor has a surface area
of approximately 1 cm². The spacing between each sen-
or and its associated disk surface is in the range of about
0.1 mm to 0.4 mm, which is a spacing selected to be
close enough for adequate sensor sensitivity yet far
enough to avoid contact between the sensor and the disk
during an external shock to the disk drive. The plates
forming the capacitive sensors can be made of alumi-
um, stainless steel, or other metal or metal alloy, or other
electrically conductive material, such as a conductive
plastic like carbon-filled PEEK (PolyEther-Ether-Ketone)
or a conductive ceramic like AITIC (Aluminum-Titani-
num-Carbide).
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[0010] Fig. 1 is a block diagram of a magnetic recording
disk drive incorporating the present invention. The disk
drive includes a housing 100 that supports a spindle mo-
tor 102 and a voice-coil-motor (VCM) actuator 104. The
housing 100 is typically a single-piece metal casting with
a base 180 and side walls, such as side wall 182. A stack
of magnetic recording disks, with the top disk 110 being
visible, is mounted on and rotatable by the spindle motor
102. A read/write head 109 is associated with the top
surface of disk 110. The head 109 may be an inductive
read/write head or a combination of an inductive write
head with a magnetoresistive read head and is located
on the trailing end of a slider 108. Slider 108 is supported
on the actuator arm 106 by a suspension 107 that enables
the slider to "pitch" and "roll" on an air-bearing generated
by the rotating disk 110. The head, slider, suspension
and actuator arm are collectively referred to as a
head-arm assembly, and there is a stack of head-arm
assemblies connected to actuator 104, with each
head-arm assembly being associated with a correspond-
ing disk surface.
[0011] The disk stack has a center of rotation about
axis 111 and is rotated in direction 115. Each disk surface
includes a magnetic recording layer with radially-spaced
concentric data tracks. The head must be maintained
substantially on the centerline of a data track to correctly
read and write data. However, during operation of the
disk drive the head experiences track misregistration
(TM R) caused by various disturbances, including
out-of-plane disk vibration. Thus, each data track has a
plurality of circumferentially or angularly-spaced servo
sectors that contain head positioning information detect-
able by the head and used in a servo feedback control
system to maintain the head on the centerline of the de-
sired data track. The servo sectors in each track are
aligned circumferentially with the servo sectors in the oth-
er tracks so that they extend across the tracks in a gen-
erally radial direction, as shown by two typical servo sec-
tors 117, 119. The servo information read by the head is
input as a position-error-signal (PES) to a servo feedback
controller 150 that provides a control signal to VCM driver
155 to move the VCM actuator 104 so that the head re-
mains on the track centerline.
[0012] The disk drive according to the present inven-
tion incorporates a plurality of capacitive sensors and a
support structure to address the problem of disk-vibra-
tion-induced TMR. A capacitive sensor is associated with
and faces each disk surface, as shown by capacitive sen-
sor 210 facing the top surface of disk 110. The capacitive
sensors are attached to the disk drive housing 100 by a
support structure 300. Each of the sensors is a plate
formed of metal or other electrically conductive material
and is located near the slider but outside the outer extent
of the generally radial path of the slider, as shown by
sensor 210 and slider 108 on the top surface of disk 110.
Each sensor is located close to its associated slider, i.e.,
e the angle formed between the line from the rotation axis
111 to the head 109 and the line from the rotation axis
111 to the center of the sensor 210 should be kept to a
minimum. The capacitive sensor 210 has a surface area
large enough to provide a capacitive signal but small
enough so that it is detecting substantially only "local"
axial displacement of the disk, i.e., displacement near
the slider 108. For a disk drive with 95 mm diameter disks,
the metallic plate forming the sensor has a surface area
of approximately 1 cm². The spacing between each sen-
or and its associated disk surface is in the range of about
0.1 mm to 0.4 mm, which is a spacing selected to be
close enough for adequate sensor sensitivity yet far
enough to avoid contact between the sensor and the disk
during an external shock to the disk drive. The plates
forming the capacitive sensors can be made of alumi-
um, stainless steel, or other metal or metal alloy, or other
electrically conductive material, such as a conductive
plastic like carbon-filled PEEK (PolyEther-Ether-Ketone)
or a conductive ceramic like AITIC (Aluminum-Titani-
um-Carbide).
[0013] The output of each capacitive sensor, such as
sensor 210, is converted by capacitance sensing circuit
250 to a voltage signal that is sent to a feedforward con-
troller 260. Feedforward controller 260 provides a cor-ection signal that is combined with the output of feedback
controller 150 to reduce the effect on TMR caused by
out-of-plane vibration of the disk.
[0014] Referring now to Fig. 2A, the capacitive sensors
are attached to a support structure 300 attached to the
disk drive housing 100. The housing 100 includes a base
180 and four side walls, one of which is shown as side
wall 182. Typically the housing 100 is formed as a sin-
gle-piece metal casting that includes base 180 and the
side walls. The spindle motor 102 is mounted to the base
180 of housing 100 and supports the axially-spaced disks
110, 120, 130 making up the disk stack. Capacitive sen-
sors 210, 220, 230 are associated with respective disks
110, 120, 130. The sensors are attached to a support
structure 300. The support structure 300 is shown as
being mounted to the base 180 of housing 100, but it can
also be mounted to side wall 182. The support structure
300 can be formed of an electrically insulating material,
such as a high strength injection-molded plastic, as
shown in Fig. 2A, so that each metallic plate is electrically
isolated from the support structure and the other metallic
plates.
[0015] The support structure 300 can also be formed
of a metallic material. Referring to Fig. 2B, the support
structure is integrated into the single-piece housing cast-
ing, in which case it is formed of the same material as
the housing, typically aluminum. If the support structure is formed of a metallic material, either as a separate structure mounted to the housing or as part of the housing casting, then electrically insulating material is located between each sensor and the support structure. As shown in Fig. 2B a support structure 300′ includes fingers 310, 320, 330 extending between the disks 110, 120, 130 near the perimeter of the disk stack and is integrated with side wall 182 as part of the single-piece housing casting. Each sensor 210, 220, 230 is located on and attached to a respective insulating layer 311, 321, 331 on fingers 310, 320, 330, respectively. The insulating layers can be formed of a plastic material, such as polyimide, that is bonded to the fingers.

During vibration of the disk the distance between the sensor and the disk surface, such as between sensor 210 and the top surface of disk 110, will change and be detected as a change in capacitance. The capacitance is inversely proportional to the gap or distance between the sensor and the disk surface by the relationship $C = \varepsilon A/g$, where $\varepsilon$ is the permittivity, $A$ is the area of the sensor plate and $g$ is the gap. Fig. 3 is an exemplary schematic of a capacitance sensing circuit 250. The outputs of the capacitive sensors, including sensor 210, are input to a multiplexer. The disk drive controller (not shown), which has selected the head that is reading or writing, provides a signal to the multiplexer so that the capacitive sensor associated with the disk on which the selected head is reading or writing is selected as the input to the sensing circuit 250. The circuit is operated at 10 MHz and the signal from the selected sensor is input to a capacitance bridge. Signals outside the range of interest are removed by a high pass filter (HPF) and a low pass filter (LPF), and the signal is amplified and output as a voltage. The voltage signal out of circuit 250 represents the gap or distance between the selected sensor and its associated disk surface and is sent to the feedforward controller 260 (Fig. 1).

The disk drive described above has been illustrated as having multiple disks in a stack and a plurality of capacitive sensors on the support structure, with one sensor being associated with each disk. However, the invention is applicable for a single-disk drive with a single capacitive sensor on the support structure. The disk drive may also have more than one capacitive sensor per disk, e.g., there may be two sensors for each disk with each sensor facing a respective one of the two disk surfaces.

The support structure 300 described above is illustrated as a separate structure dedicated to supporting the capacitive sensors in the desired location relative to the disk stack. However, to reduce fabrication cost the capacitive sensors can also be supported by a support structure that serves other functions in the disk drive. For example, if the disk drive includes damping plates that extend between the disks near their outer perimeter to reduce out-of-plane disk vibration, the sensors can be supported by the damping plate support structure, or each sensor can be located on a corresponding damping plate. If the disk drive includes a shroud surrounding the disk stack for containing air flow inside the rotating disk stack, the capacitive sensors can be supported by the shroud support structure or integrated with the shroud. If the disk drive includes air dams between the disks for diverting airflow away from the head-suspension-arm assemblies, the capacitive sensors can be supported by the air dam support structure, with each sensor located on a corresponding air dam. If the disk drive is a "load/unload" type of disk drive that uses load/unload ramps that extend between the disks, so that when power to the disk drive is removed each head-suspension assembly is moved up onto a ramp, the capacitive sensors can be supported by the ramp support structure.

Fig. 4A is a top view and Fig. 4B is a partial side sectional view, respectively, of a disk drive with damping plates extending over a radially outer annular sector of the region swept by the rotating disks. The damping plates are supported on support structure 400 which is integrally formed with the housing wall 182 as part of the fabrication of housing 100. However, the damping plates may also be formed as a separate assembly and mounted to base 180 or wall 182 after fabrication of housing 100. The support structure supports damping plates 410, 420, 430, 440 that damp the out-of-plane vibration of disks 110, 120, 130. Near the circumferential end of the damping plates, in the region near the sliders, as shown by section line A-A in Fig. 4A, the capacitive sensors are attached to recesses in the damping plates. The capacitive sensors 210, 220, 230 are secured to layers of insulating material 411, 421, 431, respectively, located on respective damping plates 410, 420, 430. Alternatively, the sensors may be attached separately to and extend out from the support structure 400, instead of being mounted on the damping plates.

Fig. 5A is a top view and Fig. 5B is a partial side sectional view, respectively, of a disk drive with a shroud located near the outer perimeter for the disk stack for containing the air flow inside the stack of disks. The shroud has slits (not shown in Fig. 5B) to permit movement of the actuator arms. The shroud is supported by support structure 500 and has a cylindrical wall 502. The support structure 500 can be formed of a plastic material and mounted to housing base 180 with insulating spacer regions 510, 520, 530 between the capacitive sensors 210, 220, 230. Alternatively, the support structure 500 can include the shroud with radially inwardly directed fingers and be incorporated as part of the metal single-piece housing casting, in which case each capacitive sensor would be located on an associated finger with an insulating layer between each sensor and the metal finger supporting it.

Fig. 6A is a top view and Fig. 6B is a partial side sectional view, respectively, of a disk drive with air dams located between the disks for disrupting the air flow near the head-suspension assemblies. A disk drive with air dams is described in published patent application US
A plastic support structure 600 is mounted to the housing base 100 and supports the radially inwardly extending air dams 610, 620, 630, 640. The capacitive sensors 210, 220, 230 are mounted on the air dams 610, 620, 630, respectively. Alternatively, the support structure 600 and the air dams can be incorporated as part of the metal single-piece housing casting, in which case each capacitive sensor would be located on an associated air dam with an insulating layer between each sensor and the metal air dam supporting it.

Fig. 7A is a top view of a disk drive with load/unload ramps located between the disks for supporting the head-suspension assemblies when the disk drive is not operating. Fig. 7B is a perspective view of the ramp support structure 700. The ramp support structure 700 is formed of plastic and mounted to the housing base 100 and supports the ramps 710, 720, 730. The support structure 700 has plastic spacer regions 711, 721, 731 that support the capacitive sensors 210, 220, 230, respectively, and electrically isolate the sensors from one another.

While the present invention has been particularly shown and described with reference to the preferred embodiments, it will be understood by those skilled in the art that various changes in form and detail may be made without departing from the scope of the invention. Accordingly, the disclosed invention is to be considered merely as illustrative and limited in scope only as specified in the appended claims.

Claims

1. A data recording disk drive comprising:
   a housing;
   a spindle motor attached to the housing and having an axis of rotation;
   at least one disk mounted on and rotatable by the spindle motor about said axis of rotation;
   at least one capacitive sensor comprising an electrically conductive plate having a planar surface facing a surface of said at least one disk; and
   a support structure attached to the housing, said at least one sensor being mounted to the support structure.

2. The disk drive of claim 1 wherein the housing comprises a base and side walls, the spindle motor being attached to the base, and wherein the support structure is mounted on the base.

3. The disk drive of claim 1 wherein the housing comprises a base and side walls, the spindle motor being attached to the base, and wherein the support structure is attached to a side wall.

4. The disk drive of claim 1 wherein the housing and support structure comprise an integrated single-piece casting.

5. The disk drive of claim 1 wherein the support structure is formed of electrically insulating material.

6. The disk drive of claim 1 wherein the support structure is formed of electrically conductive material and further comprising an insulating spacer located between said at least one sensor and the support structure.

7. The data recording disk drive of claim 1 comprising:
   a plurality of axially-spaced disks mounted on and rotatable by the spindle motor about said axis of rotation;
   a plurality of capacitive sensors, each sensor comprising an electrically conductive plate having a planar surface facing a surface of an associated disk; and
   a support structure attached to the housing, each sensor being mounted to the support structure.

8. The disk drive of claim 7 wherein the disk drive further comprises a plurality of damping plates extending between the axially-spaced disks, the damping plates extending circumferentially around a sector of the disks and radially across a radially outer annular region of the disks; and wherein each damping plate is attached to said support structure.

9. The disk drive of claim 7 wherein each sensor is attached to an associated damping plate.

10. The disk drive of claim 7 wherein the support structure comprises a shroud located around a portion of the outer perimeter of the axially-spaced disks for containing the air flow; and wherein each sensor extends from the shroud to face its associated disk surface near the outer perimeter of its associated disk.

11. The disk drive of claim 7 wherein the disk drive further comprises a plurality of recording heads, a rotary actuator having a plurality of arms that support the heads and extend between the axially-spaced disks, and a plurality of air dams extending between the axially-spaced disks for diverting air flow induced by the rotating disks; and wherein each air dam is attached to said support structure.

12. The disk drive of claim 11 wherein each sensor is attached to an associated air dam.

13. The disk drive of claim 7 wherein the disk drive further comprises a plurality of recording heads, a rotary...
actuator having a plurality of arms that support the heads and extend between the axially-spaced disks, and a plurality of ramps extending between the axially-spaced disks for locating the heads away from the disks when the disk drive is not operating; and wherein each ramp is attached to said support structure.

14. The disk drive of claim 13 wherein the support structure and ramps are a single-piece structure of plastic material, the single-piece structure including spacer regions, each sensor being attached to a spacer region.

15. A capacitive sensor assembly comprising:
   a support structure having a plurality of generally parallel fingers;
   a plurality of capacitive sensors, each sensor attached to a respective finger and comprising a metallic plate having a planar surface.

16. The assembly of claim 15 wherein the support structure is formed of electrically insulating material.

17. The assembly of claim 15 wherein the support structure is formed of electrically conducting material and further comprising a layer of insulating material located between each sensor and its respective finger.

18. The assembly of claim 15 further comprising a capacitance sensing circuit electrically connected to each sensor.

19. The assembly of claim 18 further comprising a multiplexer for selecting one of the sensors for input to said sensing circuit.